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| Notice of References Cited | Application/Control No. 10/024,145 | Applicant(s)/Patent Under Reexamination NAKAYAMA, SHIGERU | |
| | Examiner Andrew Hwa S. Lee | Art Unit 2877 | Page 1 of 1 |

U.S. PATENT DOCUMENTS

| * | | Document Number Country Code-Number-Kind Code | Date MM-YYYY | Name | Classification |
|---|---|--|-----------------|--------------------|----------------|
| | A | US-4,761,071 | 08-1988 | Baron, William S. | 351/212 |
| | B | US-4,305,398 | 12-1981 | Sawa, Seiji | 600/323 |
| | C | US-4,117,322 | 09-1978 | McKinney, James T. | 250/309 |
| | D | US-4,283,147 | 08-1981 | Dreyfus et al. | 356/445 |
| | E | US-4,943,733 | 07-1990 | Mori et al. | 250/548 |
| | F | US- | | | |
| | G | US- | | | |
| | H | US- | | | |
| | I | US- | | | |
| | J | US- | | | |
| | K | US- | | | |
| | L | US- | | | |
| | M | US- | | | |

FOREIGN PATENT DOCUMENTS

| * | | Document Number Country Code-Number-Kind Code | Date MM-YYYY | Country | Name | Classification |
|---|---|--|-----------------|---------|------|----------------|
| | N | | | | | |
| | O | | | | | |
| | P | | | | | |
| | Q | | | | | |
| | R | | | | | |
| | S | | | | | |
| | T | | | | | |

NON-PATENT DOCUMENTS

| * | | Include as applicable: Author, Title Date, Publisher, Edition or Volume, Pertinent Pages) |
|---|---|---|
| | U | |
| | V | |
| | W | |
| | X | |

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